

# **Customer Information Notification**

Issue Date: 19-Aug-2020 Effective Date: 20-Aug-2020

Dear Emma Tempest,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP.

For detailed information we invite you to <u>view this</u> notification online

This notice is NXP Company Proprietary.

# 2020080221



Change Category				
[] Wafer Fab Process	[] Assembly Process	[] Product Marking	[] Test Location	[] Design
[] Wafer Fab Materials	[] Assembly Materials	[] Mechanical Specification	[]Test Process	[X] Errata
[] Wafer Fab Location	[] Assembly Location	[] Packing/Shipping/Labeling	[] Test g Equipment	[] Electrical spec./Test coverage
[] Firmware	[] Other			· ·

PF8100\_PF8200 Errata
Update Rev 2.0 for Output
Overshoot / Undershoot

## **Description**

NXP Semiconductors announces an errata update for the PF8100 and PF8200 devices, which could potentially be affected by an observed errata condition. The errata sheet describes existing deviations from the data sheet identified on current production devices. Potential implications on customer applications are described. The updated document provides a detailed description of the changes. Changes are summarized below.

### Errata Update

ER101: Output overshoot / undershoot when enabling another regulator

- Errata has been updated to capture additional conditions associated with ER101.
- Complete behavior including workaround is described in the errata.
- Severity Level: Medium

The errata ES\_PF8100\_PF8200 revision 2.0 is attached to this notice and can be found at:

## https://www.nxp.com/docs/en/errata/ES PF8100 PF8200 2.pdf

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02

#### Reason

Errata update has been released to capture additional conditions associated with ER101, which could potentially affect some PF8100 and PF8200 device configurations.

### **Identification of Affected Products**

Product identification does not change

## Anticipated Impact on Form, Fit, Function, Reliability or Quality

Customer application should take into account the identified errata.

No impact on form, fit, function, reliability or quality - no change to existing device.

### **Data Sheet Revision**

No impact to existing datasheet

#### Additional information

Affected products and sales history information: see attached file

Additional documents: view online



### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please <u>contact NXP "Global Quality Support Team"</u>.

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Joaquin Romo

**Position** System and Applications Engineer

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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